

Form 1449 (Modified) Information Disclosure Statement By Applicant (Use Several Sheets if Necessary)	Atty Docket No.	Application No.:
	ALTRP084C1	Not yet assigned
	Applicant:	101775370
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U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
BA	A1	6,307,160	10.2001	Mei et al.			
BA	A2	6,286,206	09.2001	Li, Chou H.			
BA	A3	6,445,069	09.2002	Ling et al.			
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Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No

Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
BA	C1	Goyal, et al, "Failure Mechanism of Brittle Solder Joint Fracture in the Presence of Electroless Nickel Immersion Gold (ENIG) Interface", Proceedings of the 52 nd Electronic Component and Technology Conference, 732-739, May 2002.
BA	C2	Binary Alloy Phase Diagrams Binary Alloy Phase Diagrams, 2 nd ed, December 1990, T.B.B. Massalski (Editor), L. Kacprzak (Editor), H. Okamoto (Editor), P.R. Subramanian (Editor), pgs 2269, 2642, 2644, 2294, 2996, 1449, 1451, 1746-1748.
Examiner		Date Considered
		12/27/04 - 10/13/05

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.